

WCNLB1106-G313

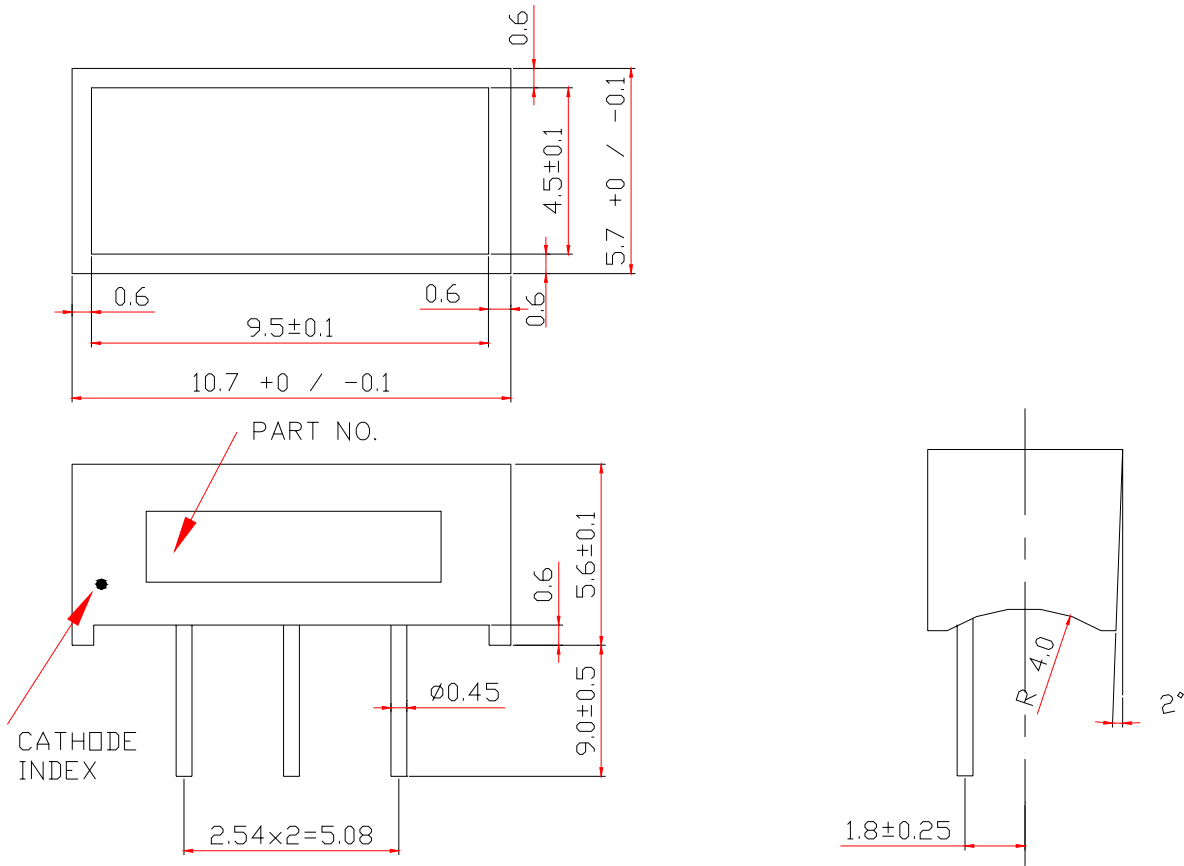
SPECIFICATION

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
Fei 2016-8-5	Athena	William	
REVISION RECORD A1:New Version issued (2016-8-5)			



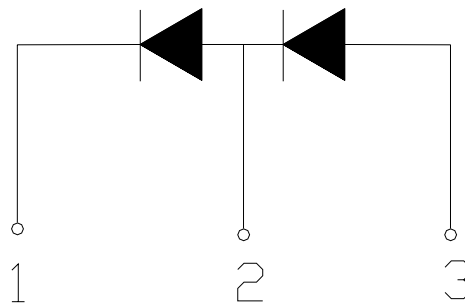
REVISION: A1

■ **Outer Dimension:**



Notes: Unless otherwise stated, The tolerance is ± 0.25 mm.

■ **Circuit Diagram:**



■ **Features:**

- **High Reliability**
- **Color: Yellow Green**
- **Low Power Requirement**
- **Easy Assembly**

■ **Description:**

- **One Window Bar Display**
- **Bar Height 4.5 mm and Width 9.5 mm**
- **White Face and Milky Bar**

■ **Absolute Maximum Rating (Ta=25°C):**

Parameter	Symbol	Condition	Color	Rating	Units
Power Dissipation Per Bar	P_d	—	Yellow Green	65	mW
Forward Current Per Bar	I_F	—	Yellow Green	25	mA
Peak Forward Current Per Bar	I_{FP}	1/10 Duty 10KHz	Yellow Green	100	mA
Reverse Voltage Per Bar	V_R	—	Yellow Green	5	V
Operating Temperature Range	T_{opr}	—	—	-35~+85	°C
Storage Temperature Range	T_{stg}	—	—	-35~+85	°C

■ **Electrical/Optical Characteristics Rating (Ta=25°C)**

Item	Symbol	Test conditions	Location	Rating			Units
				Min.	Typ.	Max.	
Forward Voltage	V_F	$I_F=20mA$	Per Bar	—	2.2	2.60	V
Reverse Current	I_R	$V_R=5V$	Per Bar	—	—	100	μA
Luminous Intensity	I_V	$I_F=10mA$	Per Bar	8501	12800	—	μcd
Wave Length	λ_P	$I_F=20mA$	Per Bar	—	568	—	nm
	λ_D				571		
Spectral Line Half Width	$\Delta \lambda$	$I_F=20mA$	Per Bar	—	30	—	nm
Luminous Intensity Matching Ratio (Bar to Bar)	I_{v-m}	$I_F=10mA$				1.2:1	

■ **Soldering Conditions:** Soldering Temp. $\leq +260^\circ C$ Soldering Time. $\leq 3sec.$
 (at 2mm Distance from The Case of Reflector Edge).

■ Typical Elector-Optical Characteristics Curve:

Fig 1. Forward Current vs. Forward Voltage

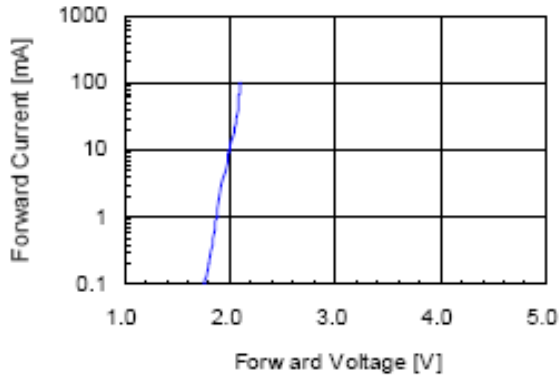


Fig 2. Relative Intensity vs. Forward Current

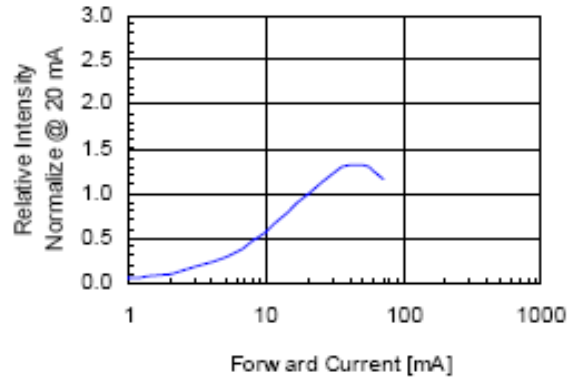


Fig 3. Forward Voltage vs. Temperature

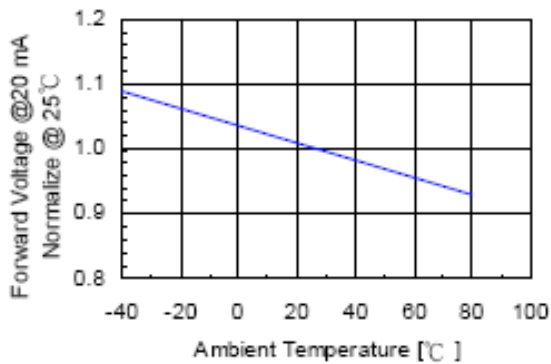


Fig 4. Relative Intensity vs. Temperature

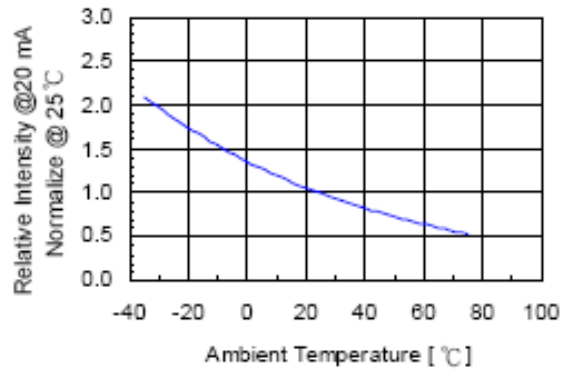
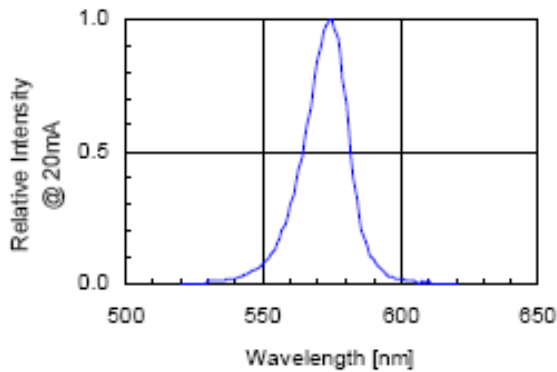


Fig 5. Relative Intensity vs. Wavelength



WCN Opto Group Co., Limited

■ LED Displays Reliability Test:

CLASSIFICATION	TEST ITEM	DESCRIPTION AND TEST CONDITION
ENDURANCE TEST	OPERATION LIFE	EVALUATES RESISTANCE OF THE DEVICE WHEN OPERATED AT ELECTRICAL STRESS T _a = UNDER ROOM TEMPERATURE I _F = I _F max
	HIGH TEMPERATURE HIGH HUMIDITY STORAGE	EVALUATES MOISTURE RESISTANCE OF THE DEVICE WHEN STORED FOR A LONG TERM AT HIGH TEMPERATURE AND HUMIDITY T _a = 65±5°C RH=90~95%RH TEST TIME=240± 2Hrs
	HIGH TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN HIGH TEMPERATURE T _a = 85±5°C (COB: T _a =65±5°C) TEST TIME=1000Hrs(-24Hrs, +72Hrs)
	LOW TEMPERATURE STORAGE	EVALUATES DEVICE DURABILITY FOR LONG TERM STORAGE IN LOW TEMPERATURE T _a = -35±5°C TEST TIME=1000Hrs(-24Hrs, +72Hrs)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	EVALUATES RESISTANCE OF DEVICE AT THERMAL STRESSES OR EXPANSION AND CONTRACTION 85°C ~ 25°C ~ -35°C ~ 25°C 30min 5min 30min 5min 10 CYCLES(COB: T _{hot} =65°C, T _{cold} =-25°C)
	THERMAL SHOCK	EVALUATES DEVICE STRUCTURE AND STRUCTURE AND MECHANICAL RESISTANCE WHEN SUDDENLY EXPOSED AT SERVE CHANGES 85±5°C ~ -35±5°C 10min 10min 10 CYCLES(COB: T _{hot} =65°C, T _{cold} =-25°C)
	SOLDERABILITY	EVALUATES SOLDERABILITY ON LEADS OF DEVICE T.SOL=230±5°C DWELL TIME=5±1sec.
	SOLDER RESISTANCE	EVALUATES RESISTANCE TO THERMAL STRESS CAUSED BY SOLDERING T.SOL=260±5°C DWELL TIME=10±1sec.

■ Packing method A:

750pcs / Red Expandable Polyethylene.

3750 pcs / Box(360*175*130mm).

22500 pcs / Catton(550*380*280mm).